

Electronic Patent Application Fee Transmittal

Application Number:	10598514			
Filing Date:				
Title of Invention:	MULTIPLE STACKED DIE WINDOW CSP PACKAGE AND METHOD OF MANUFACTURE			
First Named Inventor/Applicant Name:	Chuen Khiang WANG			
Filer:	Daniel Brian Moon/Ramon Linsangan			
Attorney Docket Number:	P26634			
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Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
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Petition:				
Patent-Appeals-and-Interference:				
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Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				130